

GaAs MMIC Double Balanced Mixer

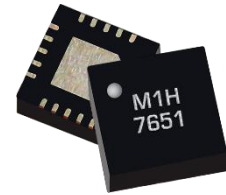
MM1-0115HPSM

1. Device Overview

1.1 General Description

The MM1-0115HPSM is a GaAs MMIC double balanced mixer that features excellent conversion loss, superior isolations and spurious performance across a broad bandwidth.

MM1-0115HPSM works well as both an up and down converter through Ku band. The MM1-0115HPSM is recommend for moderate power applications that demand high linearity. The MM1-0115HPSM is available in a 4x4 mm QFN package. Evaluation boards are also available. For a list of recommended LO driver amps for all mixers and IQ mixers, see [here](#).



QFN

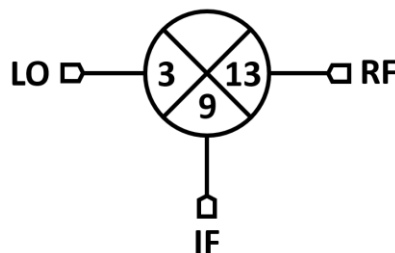
1.2 Features

| Parameter | Typical |
|--------------------|--------------|
| RF/LO response | 1GHz - 15GHz |
| IF response | DC – 2.5 GHz |
| Conversion Loss | 8.0dB |
| LO to RF Isolation | 52dB |

1.3 Applications

- Test and measurement equipment
- SATCOM
- Radar
- Electronic Warfare

1.4 Functional Block Diagram



1.5 Part Ordering Options¹

| Part Number | Description | Package | Green Status | Product Lifecycle | Export Classification |
|----------------|----------------------------------|---------|--------------|-------------------|-----------------------|
| MM1-0115HPSM-2 | 4x4 mm QFN | PSM | RoHS | Active | EAR99 |
| EVB-MM1-0115HP | Connectorized Evaluation Fixture | EVB | | Active | EAR99 |

¹ Refer to our [website](#) for a list of definitions for terminology presented in this table.

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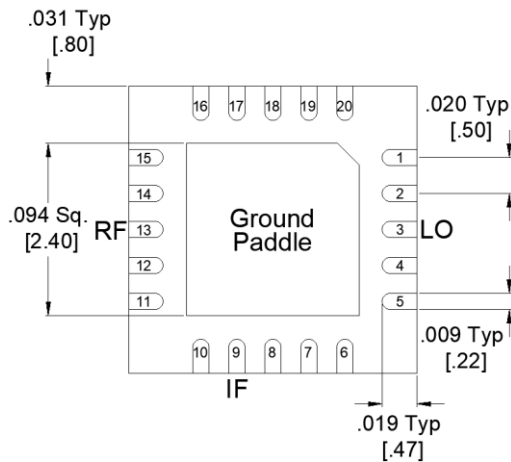
Revision History

| Revision Code | Revision Date | Comment |
|---------------|---------------|---------------------------|
| - | October 2022 | Datasheet Initial Release |

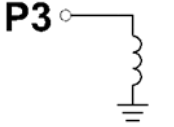
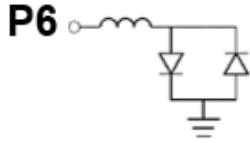
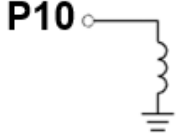
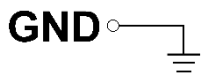
2. Port Configurations and Functions

2.1 Port Diagram

A bottom-up view of the MM1-0115HPSM's PSM package outline drawing is shown below. The MM1-0115HPSM has the input and output ports given in Port Functions. The MM1-0115HPSM can be used in either an up or down conversion. For configuration A, input the LO into pin 3, use pin 13 for the RF, and port 9 for the IF. For configuration B, input the LO into pin 13, use pin 3 for the RF, and pin 9 for the IF.



2.2 Port Functions

| Port | Function | Description | Equivalent Circuit for Package |
|--------|--|--|---|
| Pin 3 | LO (Configuration A) RF (Configuration B) | Pin 3 is DC short and AC matched to 50 Ohms from 1 to 15 GHz. Blocking capacitor is optional. |  |
| Pin 9 | IF | Pin 9 is DC coupled to the diodes. Blocking capacitor is optional. |  |
| Pin 13 | RF (Configuration A) LO (Configuration B) | Pin 13 is DC short and AC matched to 50 Ohms from 1 to 15 GHz. Blocking capacitor is optional. |  |
| GND | Ground | SM package ground path is provided through the ground paddle. |  |

3. Specifications

3.1 Absolute Maximum Ratings

The Absolute Maximum Ratings indicate limits beyond which damage may occur to the device. If these limits are exceeded, the device may be inoperable or have a reduced lifetime.

| Parameter | Maximum Rating | Units |
|-----------------------------|----------------|-------|
| Pin 3 DC Current | 30 | mA |
| Pin 9 DC Current | 30 | mA |
| Pin 13 DC Current | 30 | mA |
| Power Handling, at any Port | +33 | dBm |
| Operating Temperature | -55 to +100 | °C |
| Storage Temperature | -65 to +125 | °C |

3.2 Package Information

| Parameter | Details | Rating |
|-----------|--|--------|
| ESD | Human Body Model (HBM), per MIL-STD-750, Method 1020 | 1A |
| Weight | PSM package | 42 mg |

3.3 Recommended Operating Conditions

The Recommended Operating Conditions indicate the limits, inside which the device should be operated, to guarantee the performance given in Electrical Specifications. Operating outside these limits may not necessarily cause damage to the device, but the performance may degrade outside the limits of the electrical specifications. For limits, above which damage may occur, see Absolute Maximum Ratings.

| | Min | Nominal | Max | Units |
|--------------------------------------|-----|---------|------|-------|
| T _A , Ambient Temperature | -55 | +25 | +100 | °C |
| LO Input Power | +13 | +17 | +21 | dBm |

3.4 Sequencing Requirements

There is no requirement to apply power to the ports in a specific order. However, it is recommended to provide a 50Ω termination to each port before applying power. This is a passive diode mixer that requires no DC bias.

3.5 Electrical Specifications

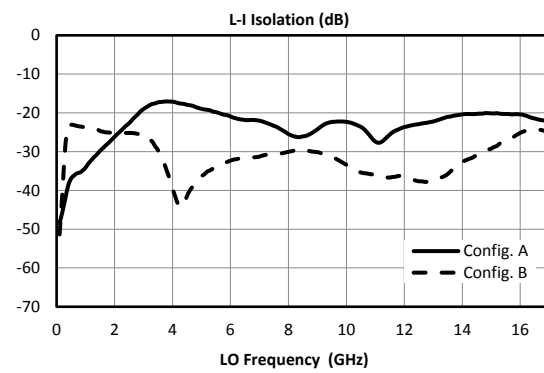
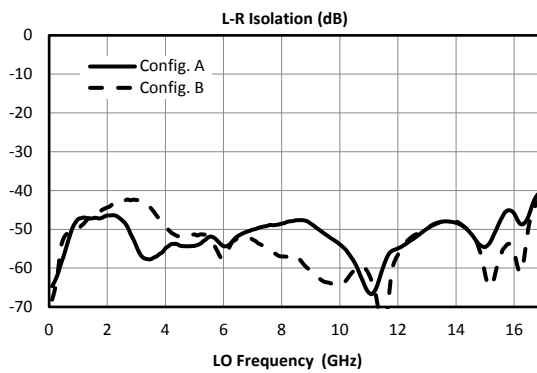
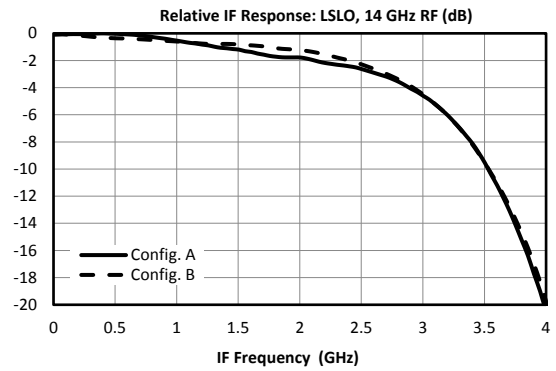
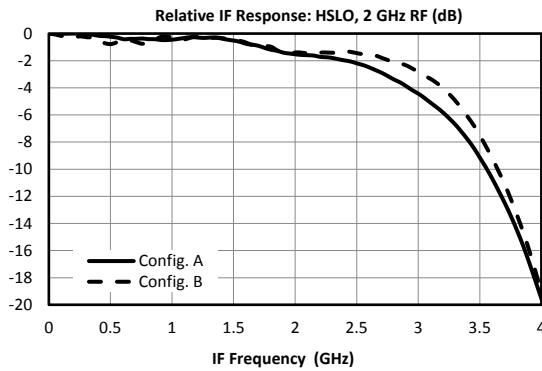
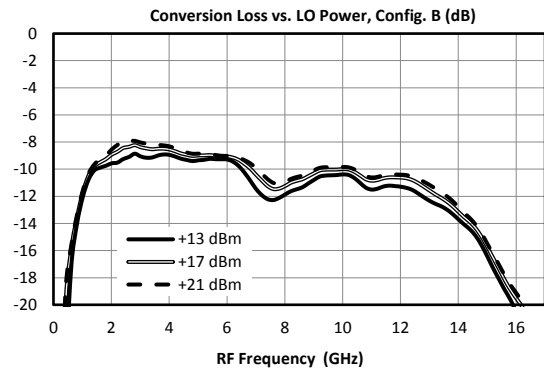
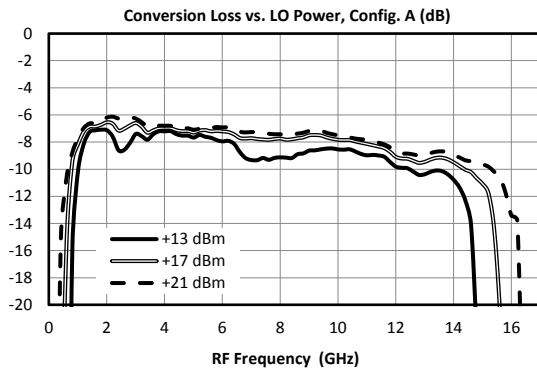
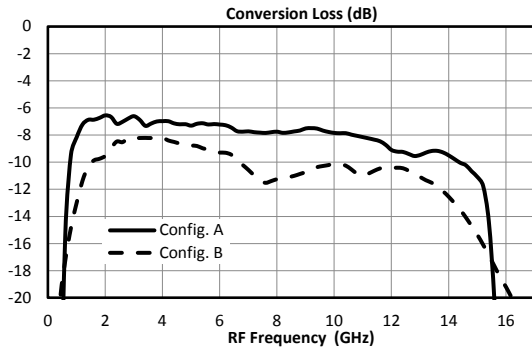
The electrical specifications apply at TA=+25°C in a 50Ω system. Typical data shown is for a down conversion application with a +17dBm sine wave LO input. Specifications shown for configuration A (B).

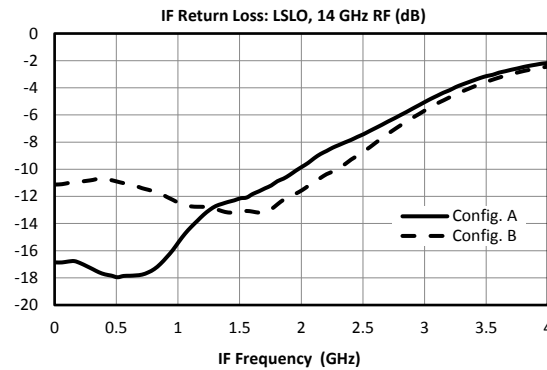
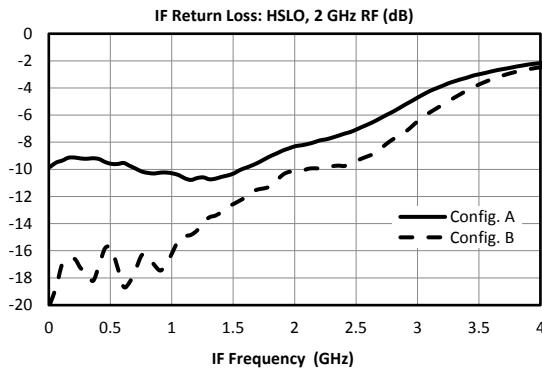
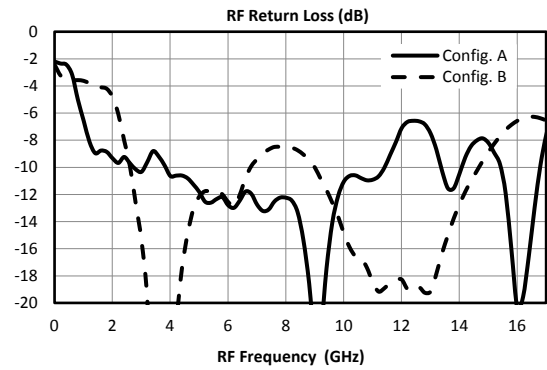
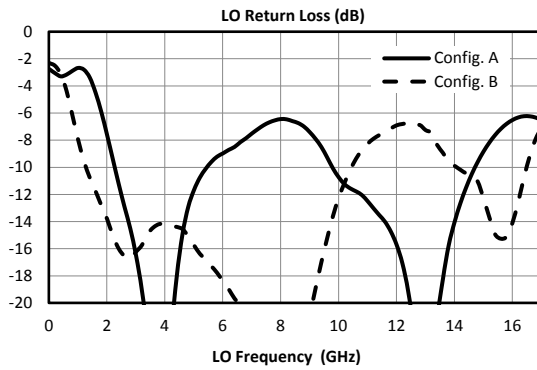
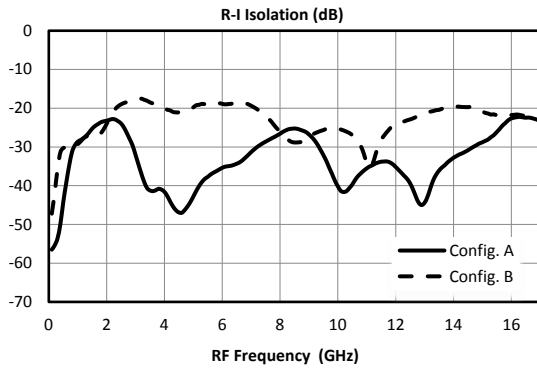
| Parameter | | Test Conditions | Min | Typical | Max | Units |
|--|----------|---|-----|---------------|----------------|-------|
| RF (Pin 13) Frequency Range | | | 1 | | 15 | GHz |
| LO (Pin 3) Frequency Range | | | 1 | | 15 | |
| I (Pin 9) Frequency Range | | | 0 | | 2.5 | |
| Conversion Loss (CL) ² | | RF/LO = 1 - 15 GHz I = DC - 0.2 GHz | | 8.0 (10.5) | 14.0 (18.5) | dB |
| | | RF/LO = 1 - 15 GHz I = 0.2 - 2.5 GHz | | 9 (11.5) | | |
| Noise Figure (NF) ³ | | RF/LO = 1 - 15 GHz I = DC - 0.2 GHz | | 8 (10.5) | | dB |
| Isolation | LO to RF | RF/LO = 1 - 15 GHz | | 52 (54) | | dB |
| | LO to IF | IF/LO = 1 - 15 GHz | | 23 (32) | | |
| | RF to IF | RF/IF = 1 - 15 GHz | | 34 (23) | | |
| Input IP3 (IIP3) | | RF/LO = 1 - 15 GHz I = DC - 0.2 GHz | | +21 (+24) | | dBm |
| Input 1 dB Gain Compression Point (P1dB) | | | | +10 (+13) | | dBm |

² Measured as a down converter to a fixed 91MHz IF.

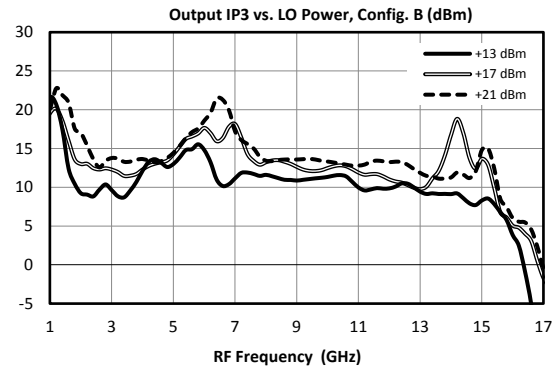
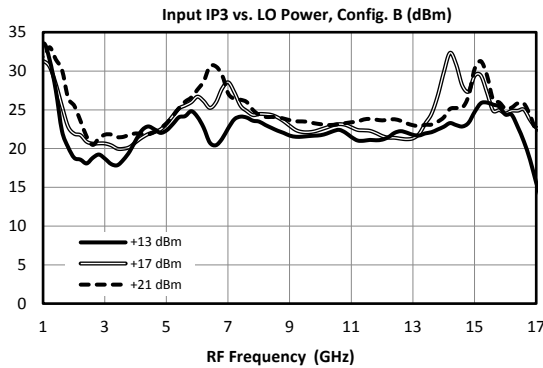
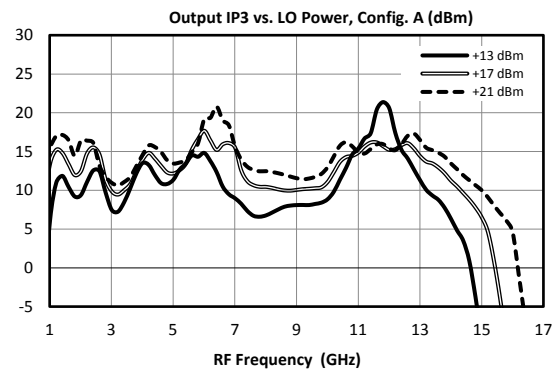
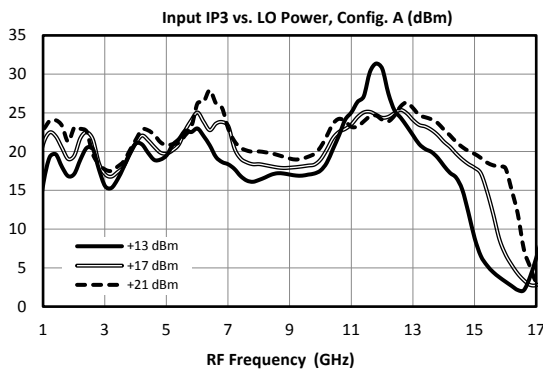
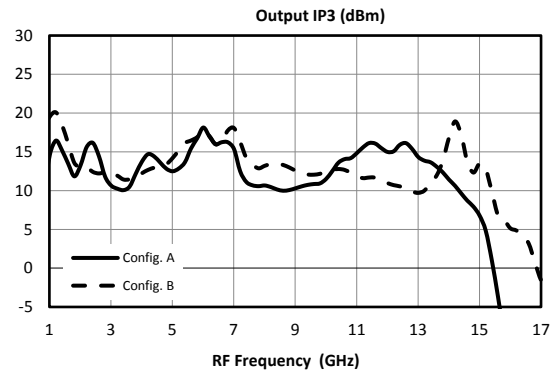
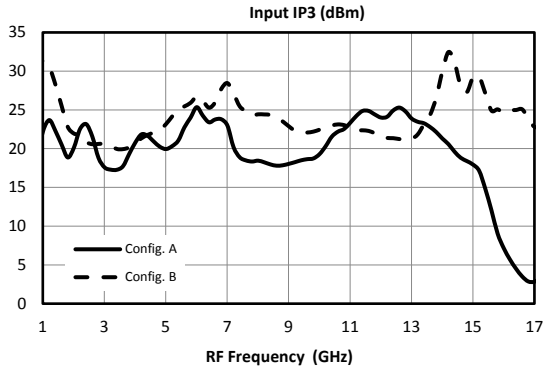
³ Mixer Noise Figure typically measures within 0.5 dB of conversion loss for IF frequencies greater than 5 MHz.

3.6 Typical Performance Plots

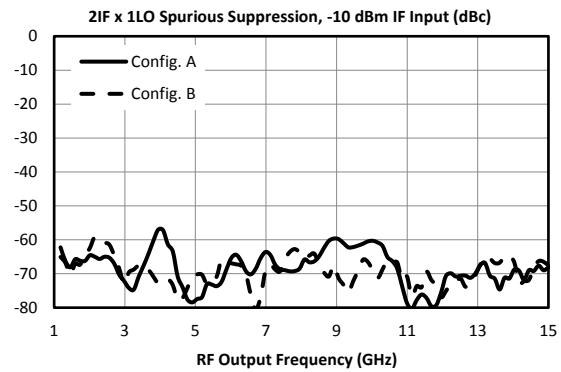
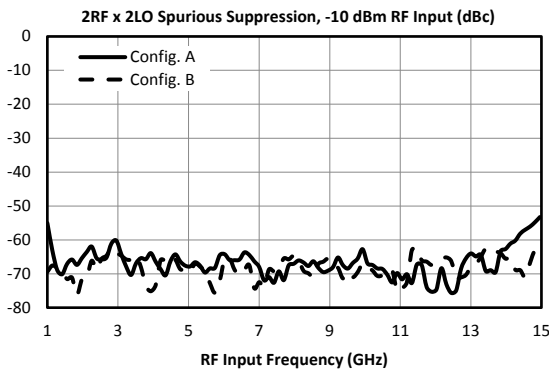
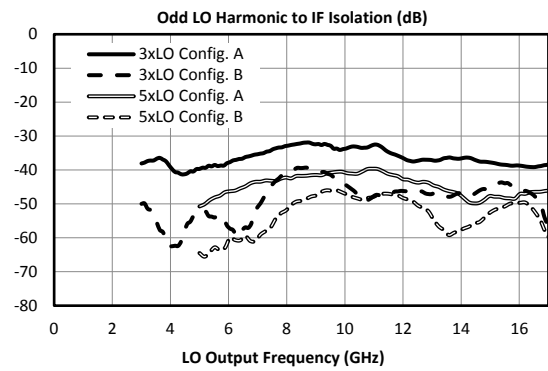
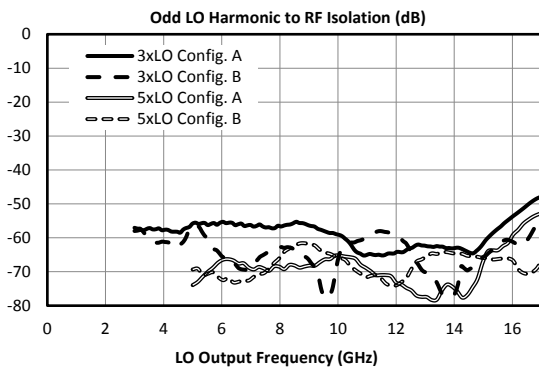
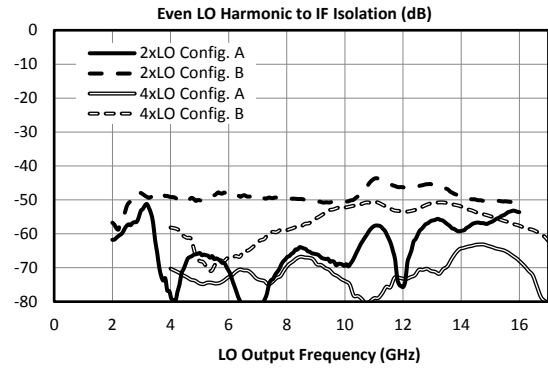
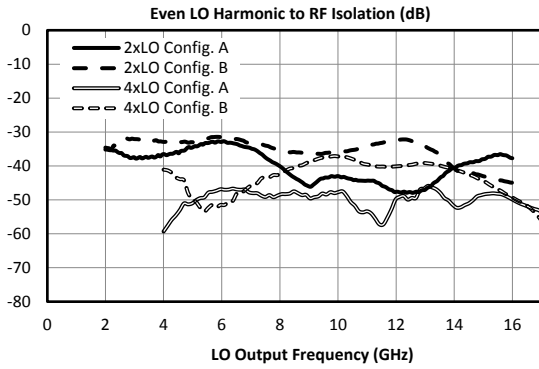




3.6.1 Typical Performance Plots: IP3



3.6.2 Typical Performance Plots: LO Harmonic Isolation



3.6.3 Typical Spurious Performance: Down-Conversion

Typical spurious data is provided by selecting RF and LO frequencies ($\pm m \cdot \text{LO} \pm n \cdot \text{RF}$) within the RF/LO bands, to create a spurious output within the IF band. The mixer is swept across the full spurious band and the mean is calculated. The numbers shown in the table below are for a -10 dBm RF input. Spurious suppression is scaled for different RF power levels by $(n-1)$, where "n" is the RF spur order. For example, the $2\text{RF} \times 2\text{LO}$ spur is 72 dBc for a -10 dBm input, so a -20 dBm RF input creates a spur that is $(2-1) \times (-10 \text{ dB})$ lower, or 82 dBc. Data is shown for the frequency plan in 3.6 Typical Performance. $m\text{LO} \times n\text{RF}$ plots can be found in section 3.6.2 Typical Performance Plots: LO Harmonic Isolation. $0\text{LO} \times 1\text{RF}$ plot is identical to the plot of LO-RF isolation.

Typical Down-conversion spurious suppression (dBc): Config A (B)

| -10 dBm RF Input | 0xLO | 1xLO | 2xLO | 3xLO | 4xLO | 5xLO |
|------------------|---------|-----------|-----------|-----------|-----------|-----------|
| 1xRF | 20 (12) | Reference | 26 (31) | 12 (11) | 36 (42) | 20 (19) |
| 2xRF | 72 (77) | 53 (55) | 72 (78) | 55 (60) | 72 (77) | 59 (58) |
| 3xRF | 85 (85) | 61 (69) | 76 (92) | 74 (72) | 80 (78) | 66 (79) |
| 4xRF | N/A | 98 (110) | 110 (116) | 101 (108) | 109 (105) | 100 (110) |
| 5xRF | N/A | 111 (123) | 119 (129) | 115 (123) | 120 (128) | 118 (126) |

3.6.4 Typical Spurious Performance: Up-Conversion

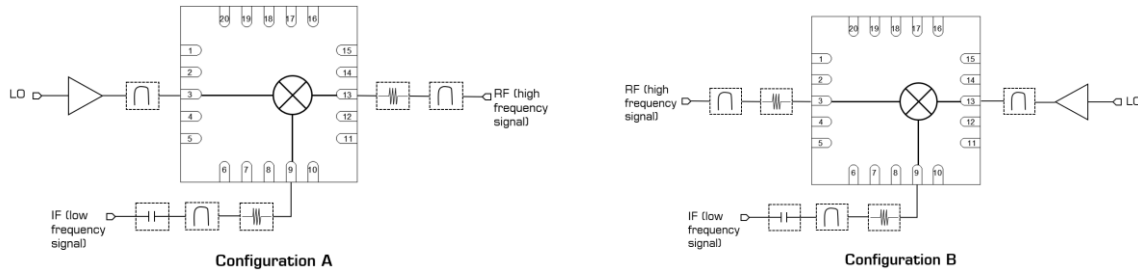
Typical spurious data is taken by mixing an input within the IF band, with LO frequencies ($\pm m \cdot \text{LO} \pm n \cdot \text{IF}$), to create a spurious output within the RF output band. The mixer is swept across the full spurious output band and the mean is calculated. The numbers shown in the table below are for a -10 dBm IF input. Spurious suppression is scaled for different IF input power levels by $(n-1)$, where "n" is the IF spur order. For example, the $2\text{IF} \times 1\text{LO}$ spur is typically 73 dBc for a -10 dBm input with a sine-wave LO, so a -20 dBm IF input creates a spur that is $(2-1) \times (-10 \text{ dB})$ lower, or 83 dBc. Data is shown for the frequency plan in 3.6 Typical Performance.

Typical Up-conversion spurious suppression (dBc): Config A (B)

| -10 dBm IF Input | 0xLO | 1xLO | 2xLO | 3xLO | 4xLO | 5xLO |
|------------------|-----------|-----------|-----------|-----------|-----------|-----------|
| 1xIF | 20 (12) | Reference | 27 (31) | 12 (10) | 34 (42) | 21 (18) |
| 2xIF | 53 (55) | 73 (72) | 60 (58) | 68 (73) | 54 (53) | 66 (68) |
| 3xIF | 87 (98) | 73 (71) | 77 (84) | 63 (65) | 78 (82) | 62 (63) |
| 4xIF | 94 (107) | 113 (116) | 98 (96) | 105 (111) | 87 (92) | 100 (105) |
| 5xIF | 115 (133) | 110 (113) | 120 (127) | 104 (108) | 111 (121) | 96 (103) |

4. Operation

4.1 Application Circuit



4.2 Ports Operation

IF Port – Used as input on an upconversion, output on downconversion, or LO port in a band shifting application. Signals should be connected by 50 ohm microstrip or coplanar traces to well matched broadband 50 ohm sources and loads. Blocking capacitor is recommended if DC voltage is present on the line.

RF Port – Used as input on a downconversion, output on upconversion, or output in a band shifting application. Signals should be connected by 50 ohm microstrip or coplanar traces to well matched broadband 50 ohm sources and loads.

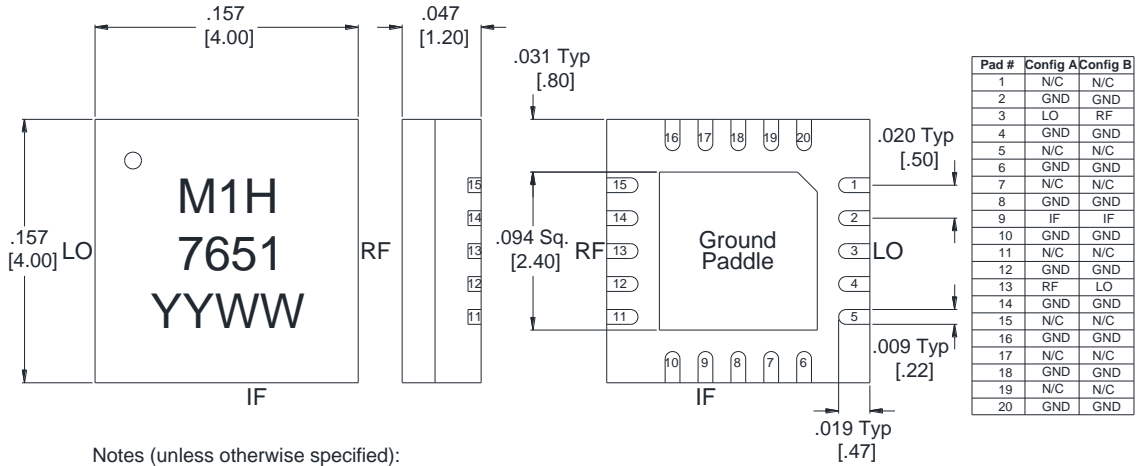
Filtering and Matching- Filtering is generally desired for spurious and image removal on the output port of the mixer. Reflective filters can cause out of band signals to reflect back into the mixer and cause conversion loss ripple, erroneous spurs, and other undesired behaviors. To eliminate these problems it is recommended that the filters be placed as close to the output port as possible. If undesired behavior is still observed, a diplexer with one port terminated or a 1-3 dB attenuator may reduce this problem.

RF Ground – The ground paddle of the QFN should be connected to a low noise RF ground with very low electrical resistance for high frequency operation.

LO Port – The noise floor of the LO input signal should be less than the value of the noise floor plus isolation of the mixer, or a filter is recommended to prevent reduction in dynamic range. An LO amplifier is required if the LO power is below the recommended drive level. It is important to use an amplifier with a broadband 50 ohm match such that it does not reflect spurious signals back into the mixer or other system circuitry.

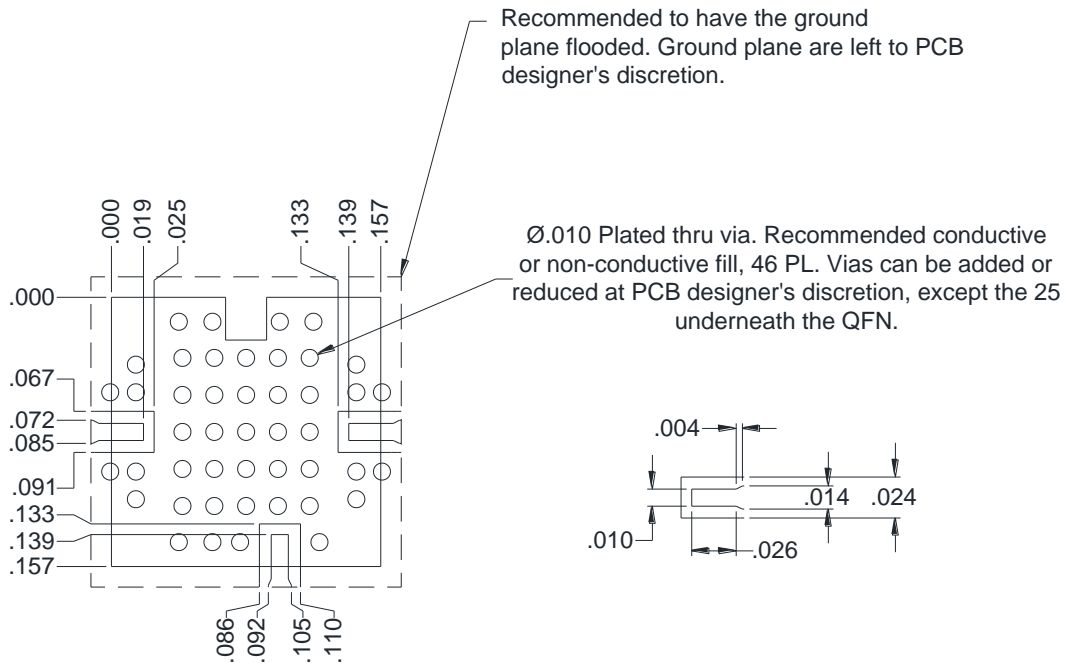
5. Mechanical Data

5.1 PSM Package Outline Drawing



- Notes (unless otherwise specified):
- Substrate material is LCP.
 - I/O Leads and QFN Paddle are:
 - 0.008 - 0.05 microns Gold, over
 - 0.08 - 0.15 microns Palladium, over
 - 0.5 - 2.0 microns Nickel
 - Ground all unconnected pins to PCB RF ground.

5.2 PSM Package Footprint

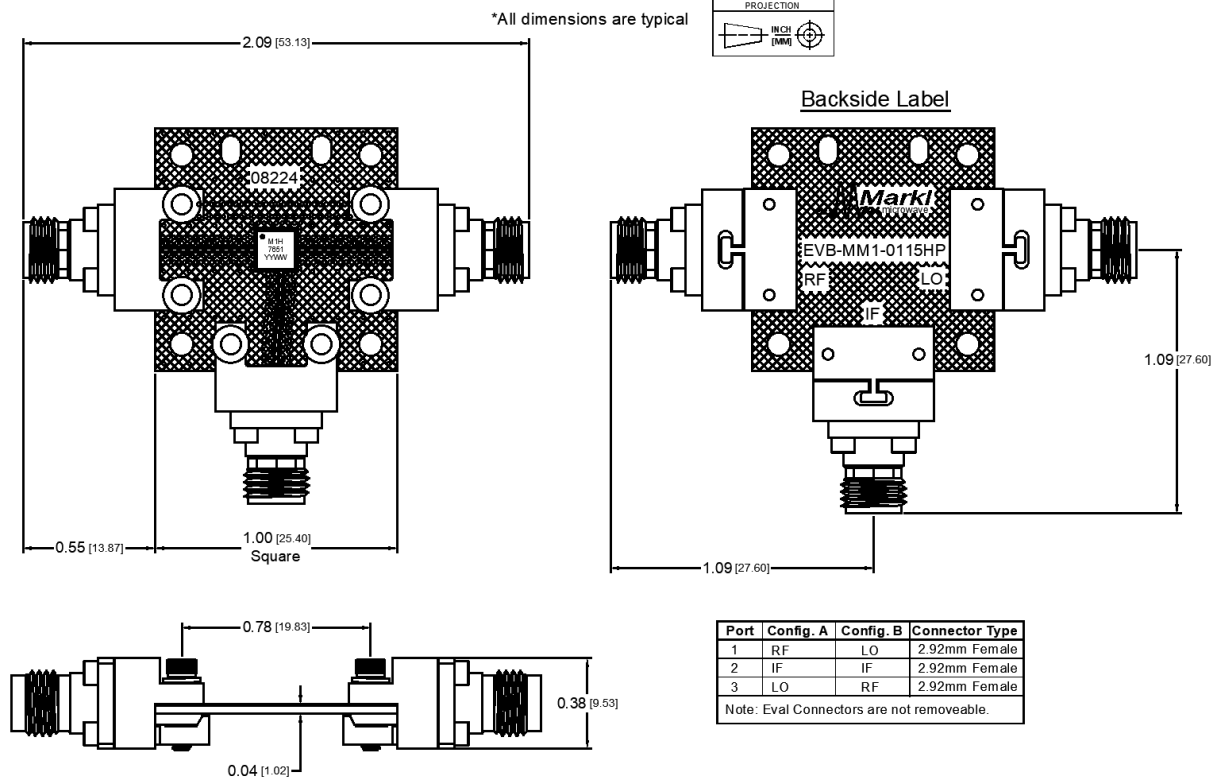


The landing pattern is to be used on Rogers 4003, 0.008" thick, 1/2 Oz Cu.

QFN-Package Surface-Mount Landing Pattern

[Click here for a DXF of the above layout.](#)
[Click here for leaded solder reflow.](#) [Click here for lead-free solder reflow.](#)

5.3 Evaluation Board Outline Drawing



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